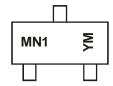


Marking Information



MN1 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: H = 2020) M or M = Month (ex: 9 = September)

Date Code Key

Year	2008		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	V		Н		J	К	L	М	N	0	Р	R
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		VDSS	60	V	
Gate-Source Voltage		V _{GSS}	±20	V	
Continuous Drain Current (Note 5) V_{GS} = 10V	Steady State	T _A = +25°C T _A = +85°C T _A = +100°C	lo	180 130 115	mA
Continuous Drain Current (Note 6) $V_{GS} = 10V$ State State TA = +25°C TA = +25°C TA = +85°C TA = +100°			lo	220 160 140	mA
Maximum Continuous Body Diode Forward Currer	nt (Note 6)	ls	220	mA	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%)	Ідм	800	mA	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Dower Dissinction	(Note 5)	D -	370	mW
Total Power Dissipation	(Note 6)	PD	540	
Thermal Desistance, Junction to Ambient	(Note 5)	Devi	348	°C/W
Thermal Resistance, Junction to Ambient	(Note 6)	Reja	241	
Thermal Resistance, Junction to Case (Note		Rejc	91	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes:

Device mounted on FR-4 PCB, with minimum recommended pad layout.
Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.

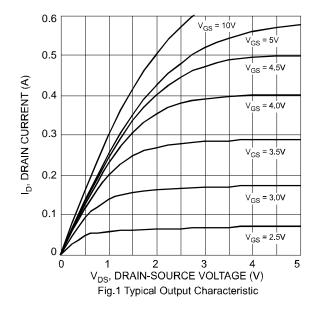


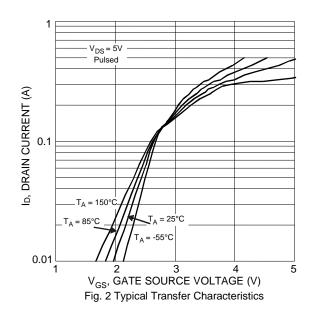
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

				I _				
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)								
Drain-Source Breakdown Voltage		BVDSS	60	70	—	V	$V_{GS} = 0V$, $I_D = 10\mu A$	
Zero Gate Voltage Drain Current	@ T _C = +25°C @ T _C = +125°C	220	_	_	1.0 500	μA	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Body Leakage		Igss	_		±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)								
Gate Threshold Voltage		VGS(TH)	1.2	_	2.0	V	V _{DS} = V _{GS} , I _D = 250µA	
Static Drain-Source On-Resistance	@ T _J = +25°C	Deserve	RDS(ON) — 3.5 6 3.0 5 9	3.5	6	0	V _{GS} = 5.0V, I _D = 0.115A	
	@ TJ = +125°C	RDS(ON)		\$2	V _{GS} = 10V, I _D = 0.115A			
Forward Transconductance		g fs	80		_	mS	V _{DS} = 10V, I _D = 0.115A	
DYNAMIC CHARACTERISTICS (Note	e 8)			•	•	•	·	
Input Capacitance		Ciss	_	23	_	pF		
Output Capacitance		Coss	_	3.4	_	pF	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance		Crss	_	1.4		pF	1	
Gate Resistance		R _G	_	260	400	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
SWITCHING CHARACTERISTICS (N	ote 8)	•		•	•	•		
Turn-On Delay Time		tD(ON)	_	10		ns	$V_{DD} = 30V, I_D = 0.115A, R_L = 150\Omega,$	
Turn-Off Delay Time		tD(OFF)	_	33	_	ns	$V_{\text{GEN}} = 10 \text{V}, \text{R}_{\text{GEN}} = 25 \Omega$	

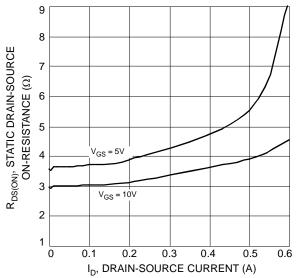
Notes:

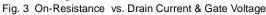
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.

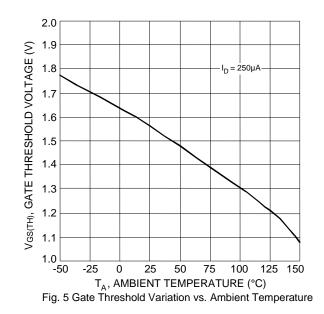


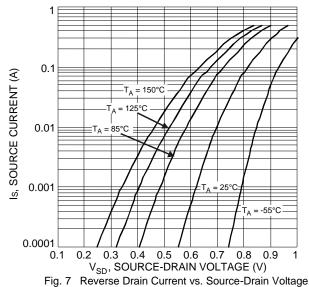


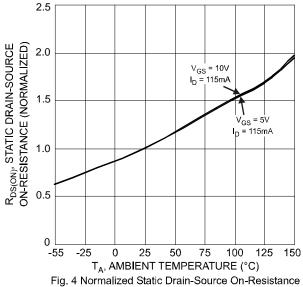




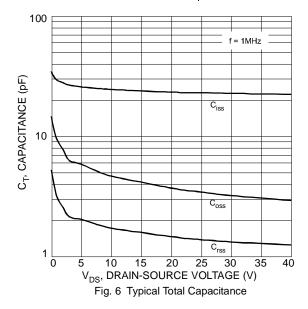








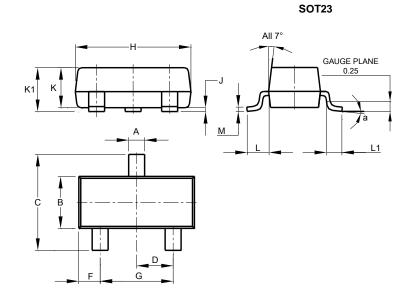






Package Outline Dimensions

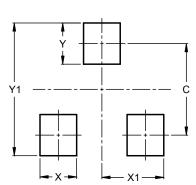
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT23							
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
в	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
К	0.890	1.00	0.975					
K1	0.903	1.10	1.025					
L	0.45	0.61	0.55					
L1	0.25	0.55	0.40					
М	0.085	0.150	0.110					
а	0°	8°						
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9

2N7002A Document number: DS31360 Rev. 14 - 2



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